

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT7764534

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JUNJIE JEFFREY SANG	05/29/2018
DALIP KUMAR	05/29/2018
KEVIN R. MULLERY	05/29/2018
RECEIVING PARTY DATA	
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State/Country:	NEW JERSEY
Postal Code:	08540
PROPERTY NUMBERS Total: 2	
Property Type	Number
Application Number:	17306581
Patent Number:	11565825
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NAME OF SUBMITTER:	CHERYLE L. TELESKO
SIGNATURE:	/Cheryle L. Telesco/
DATE SIGNED:	01/27/2023
Total Attachments: 2	
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source=15009S_US_PCT_Assignment_Signed by all#page2.tif	

ASSIGNMENT OF APPLICATION

WHEREAS I, (WE)

- **Junjie Jeffrey SANG, 26 Ohio State Drive, Newark, DE 19713 (US);**
- **Dalip Kumar KOHLI, 2909 Meadow View Way, Churchville, MD 21028 (US);**
- **Kevin R. MULLERY, 619 Timber Wood Blvd., Newark, DE 19702 (US),**

respectively, have invented certain new and useful improvements in :
"SURFACING MATERIALS FOR COMPOSITE STRUCTURES"

(Application No. **15/778035**, filed on **May 22, 2018**), and

WHEREAS, **CYTEC INDUSTRIES INC.**

(hereinafter referred to as "ASSIGNEE") having a place of business at :

**504 Carnegie Center
Princeton, New Jersey 08540**

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and all rights under the International Convention for the Protection of Industrial Property, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefore in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

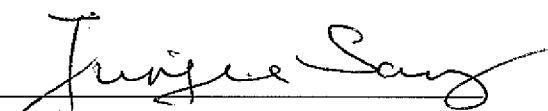
I(WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any

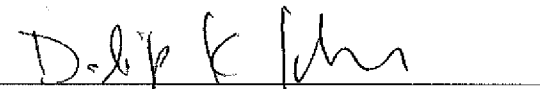
and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the patent practitioner(s) of SOLVAY USA Inc., 504 Carnegie Center, Princeton, NJ 08540 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

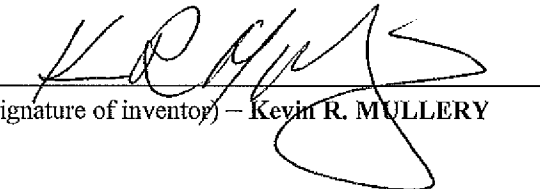
Date : 05/29/18
05/29/2018


(Signature of inventor) – Junjie Jeffrey SANG

Date : 05/29/18
05/29/2018


(Signature of inventor) – Dalip Kumar KOHLI

Date : 05/29/18
05/29/2018


(Signature of inventor) – Kevin R. MULLERY

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